Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	3010138	substrate substrates wafer wafers semiconductor semiconductors	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 09:21
L2	25164	dicing	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 09:21
L3	171036	saw saws	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 09:21
L4	132436	chuck chucks	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 09:22
L5	317	l1 and l2 and l3 and l4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 09:22
L6	24	"5809987"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 09:27

L7	116	("2762954"|"2865082"|"3664389" |"3688815"|"3691707"|"3795164" |"3892156"|"3961547"|"4006656" |"4102227"|"4138304"|"4150912" |"4246595"|"4259886"|"4287256" |"4287798"|"4343662"|"4356374" |"4358978"|"4451972"|"4513544" |"4633847"|"4688540"|"4705016" |"4804641"|"4903437"|"4937653" |"4971021"|"5046392"|"5059899" |"5128282"|"5259149"|"5316559" |"5323150"|"5326428"|"5362681" |"5373834"|"5458034"|"5461008" |"5468541"|"5521125"|"5579671" |"5580831"|"5809987"|"5851845" |"5907984"|"6087202"|"6102023" |"6112735"|"6112740"|"6117707" |"6119675"|"6130473"|"6165232").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 09:28
L8	429	l5 l7	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 09:30
L9	20	l8 and ((locate locating location) with (pin pins))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 09:31
L10	28	l8 and ((locate locating location) with (pin pins sensor sensors feeler feelers))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 09:32
L11	8	l10 not l9	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 09:33
L12	167	l5 and (location locating)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 09:33

L13	4	"6736592"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/06 10:08